

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
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DAISUKE MOTOYA	07/16/2014
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14388836
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DATE SIGNED:	09/30/2014
Total Attachments: 2	
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PATENT

Docket No:

ASSIGNMENT

This is an Assignment of the following rights, title and interest:

- United States of America rights, title and interest in the invention
- Foreign rights, title and interest in the invention
- International Application No. PCT/JP2013/058954
Date of Filing: March 27, 2013
- For which an application for a U.S. Patent was executed on _____
- United States Patent Application Serial No. _____
Date of Filing: _____

Title of the Invention: **PROCESS FOR PRODUCING WELDED JOINT, AND WELDED JOINT**

Inventors (Assignors): **YAMADA Kenta, HAMADA Masahiko, MOTOYA Daisuke, NAKATSUKA Shinjiro, AMAYA Hisashi, and TAKABE Hideki**

Assignee(s): **NIPPON STEEL & SUMITOMO METAL CORPORATION
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Tokyo 100-8071 JAPAN**

Whereas, we, the above-identified Inventors, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter referred to as "Invention");

And, whereas we desire to assign our above-identified rights, title and interest in the Invention to the above-identified assignee;

Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said applications(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, which may be granted or have granted for said Invention, and in and to any and all reissues and reexaminations thereof, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States, unto said Assignee.

And we hereby authorize and request the Commissioner of Patents and Trademarks to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And we further agree to sign and execute all necessary and lawful future documents, including applications, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

Kenta Yamada
Signature: YAMADA, Kenta

July 16, 2014
Date

Masahiko Hamada
Signature: HAMADA, Masahiko

July 16, 2014
Date

Daisuke Motoya
Signature: MOTOYA, Daisuke

July 16, 2014
Date

Shinjiro Nakatsuka
Signature: NAKATSUKA, Shinjiro

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Signature: AMAYA, Hisashi

July 16, 2014
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Signature: TAKABE, Hideki

July 16, 2014
Date